



Material Content Data Sheet



Sales Product Name		CDM10VD-3		Issued		1. August 2018		
MA#		MA001678396						
Package		PG-SOT23-6-1		Weight*		18.49 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.215	1.16	1.16	11610	11610
leadframe	inorganic material	phosphorus	7723-14-0	0.002	0.01		118	
	non noble metal	zinc	7440-66-6	0.009	0.05		473	
	non noble metal	iron	7439-89-6	0.175	0.95		9454	
wire	non noble metal	copper	7440-50-8	7.097	38.39	39.40	383879	393924
	noble metal	gold	7440-57-5	0.061	0.33	0.33	3288	3288
	encapsulation	organic material	carbon black	1333-86-4	0.020	0.11		1093
plastics	plastics	epoxy resin	-	1.546	8.36		83642	
	inorganic material	silicondioxide	60676-86-0	8.540	46.20	54.67	461947	546682
leadfinish	non noble metal	tin	7440-31-5	0.465	2.51	2.51	25142	25142
plating	noble metal	silver	7440-22-4	0.167	0.90	0.90	9037	9037
glue	plastics	acrylic resin	-	0.042	0.23		2270	
	noble metal	silver	7440-22-4	0.149	0.80	1.03	8047	10317
*deviation	< 10%					Sum in total:	100.00	1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com